



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: WHONCHEE LEE ET AL.

APPLICATION No.: 09/888,084

FILED: JUNE 21, 2001

FOR: **METHODS AND APPARATUS FOR  
ELECTRICAL, MECHANICAL AND/OR  
CHEMICAL REMOVAL OF  
CONDUCTIVE MATERIAL FROM A  
MICROELECTRONIC SUBSTRATE**

EXAMINER: DUNG V. NGUYEN

ART UNIT: 3723

CONF. No: 8101

*#20/Amdb*  
*D*  
*(HTE)*  
*M. Watts*  
*3/19/04*

Amendment Under 37 C.F.R. § 1.116

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Final Office Action dated December 22, 2003 in the above-identified application. Please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims beginning on page 2.

*Please enter*  
*dvw*  
*3-26-04*

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02 FC:1201 172.00 OP

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